NSN 5962-01-274-7052

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-01-274-7052 **Body Length:** 0.560 inches **Body Width:** 0.458 inches **Body Height:** 0.120 inches **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+125.0 degrees celsius **End Application:** F/a-18 hornet aircraft **Features Provided:** Hermetically sealed and burn in and ultraviolet erasable and programmable and w/enable and electrostatic sensitive **Inclosure Material:** Ceramic **Inclosure Configuration:** Leadless flat pack **Output Logic Form:** N-type metal oxide-semiconductor logic **Input Circuit Pattern:** 16 input **Terminal Surface Treatment:** Solder **Time Rating Per Chacteristic:** 250.00 nanoseconds propagation delay time, low to high level output and 250.00 nanoseconds propagation delay time, high to low level output **Memory Device Type:** Rom **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 32 leadless Shelf Life: N/a **Unit Of Measure: Demilitarization:**

Fiig: A458a0

Yes - demil/mli